

3rd T4CM - Type IV ILC Cryomodule Meeting

Monday, 22 January 2007 - Wednesday, 24 January 2007

INFN Milano - Laboratorio LASA

Scientific Programme

Three days focussed on design and engineering issues needed to proceed with the Fourth Generation Cryomodule for the ILC. Topics under discussion include: string layout, thermal and cryogenic design, mechanical design, design for manufacturing issues.